

## **Application Data Sheet**

### **Application Information**

Application Type:: Regular  
Subject Matter:: Utility  
Title:: Semiconductor multipackage module including processor and memory package assemblies  
Attorney Docket Number:: CPAC 1041-2  
Suggested Drawing Figure::  
Total Drawing Sheets::  
Small Entity?:: No

### **Applicant Information**

Applicant Authority Type: Inventor  
Primary Citizenship Country: US  
Status: Full Capacity  
Given Name: Marcos  
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State or Province of Residence: CA  
Country of Residence: US  
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## Correspondence Information

Correspondence Customer Number:: 22470

## Representative Information

Representative Customer Number::	22470	
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## Domestic Priority Information

Application::	Continuity Type::	Parent Application::	Parent Filing Date::
This application	An application claiming the benefit under 35 USC 119 (e)	60460541	June 4, 2003

## Assignee Information

Assignee name:: ChipPAC, Inc  
Street of mailing address:: 47400 Kato Road  
City of mailing address:: Fremont  
State or Province of mailing address:: CA  
Country of mailing address:: US  
Postal or Zip Code of mailing address:: 94538